

# MMBZ52xxBLT1G Series, SZMMBZ52xxBLT1G Series

## Zener Voltage Regulators 225 mW SOT-23 Surface Mount

This series of Zener diodes is offered in the convenient, surface mount plastic SOT-23 package. These devices are designed to provide voltage regulation with minimum space requirement. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

### Features

- 225 mW Rating on FR-4 or FR-5 Board
- Zener Voltage Range – 2.4 V to 91 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 KV) per Human Body Model
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant\*

### Mechanical Characteristics

**CASE:** Void-free, transfer-molded, thermosetting plastic case

**FINISH:** Corrosion resistant finish, easily solderable

**MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:**

260°C for 10 Seconds

**POLARITY:** Cathode indicated by polarity band

**FLAMMABILITY RATING:** UL 94 V-0

### MAXIMUM RATINGS

Rating	Symbol	Max	Units
Total Power Dissipation on FR-5 Board, (Note 1) @ $T_A = 25^\circ\text{C}$ Derated above $25^\circ\text{C}$	$P_D$	225 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Power Dissipation on Alumina Substrate, (Note 2) @ $T_A = 25^\circ\text{C}$ Derated above $25^\circ\text{C}$	$P_D$	300 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

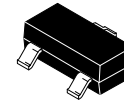
1. FR-5 = 1.0 X 0.75 X 0.62 in.
2. Alumina = 0.4 X 0.3 X 0.024 in, 99.5% alumina.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

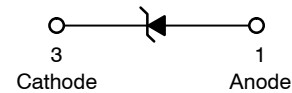


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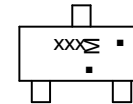
<http://onsemi.com>



**SOT-23  
CASE 318  
STYLE 8**



### MARKING DIAGRAM



- xxx = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping†
MMBZ52xxBLT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
SZMMBZ52xxBLT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
MMBZ52xxBLT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel
SZMMBZ52xxBLT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### DEVICE MARKING INFORMATION

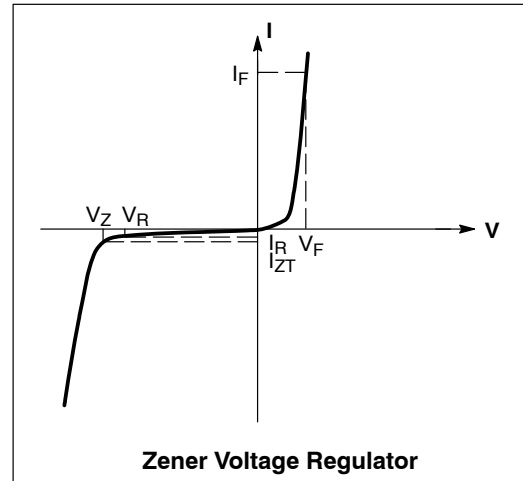
See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

## MMBZ52xxBLT1G Series, SZMMBZ52xxBLT1G Series

### ELECTRICAL CHARACTERISTICS

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) ( $T_A = 25^\circ\text{C}$  unless otherwise noted,  $V_F = 0.95\text{ V Max. @ } I_F = 10\text{ mA}$ )

Symbol	Parameter
$V_Z$	Reverse Zener Voltage @ $I_{ZT}$
$I_{ZT}$	Reverse Current
$Z_{ZT}$	Maximum Zener Impedance @ $I_{ZT}$
$I_{ZK}$	Reverse Current
$Z_{ZK}$	Maximum Zener Impedance @ $I_{ZK}$
$I_R$	Reverse Leakage Current @ $V_R$
$V_R$	Reverse Voltage
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$



## MMBZ52xxBLT1G Series, SZMMBZ52xxBLT1G Series

**ELECTRICAL CHARACTERISTICS** (Pinout: 1-Anode, 2-NC, 3-Cathode) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$  for all types.)

Device*	Device Marking	Zener Voltage (Note 3)				Zener Impedance			Leakage Current	
		V <sub>Z</sub> (Volts)			@ I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub>		I <sub>R</sub> @ V <sub>R</sub>	
		Min	Nom	Max	mA	Ω	Ω	mA	μA	Volts
MMBZ5221BLT1G	18A	2.28	2.4	2.52	20	30	1200	0.25	100	1
MMBZ5222BLT1G	18B	2.37	2.5	2.63	20	30	1250	0.25	100	1
MMBZ5223BLT1G	18C	2.56	2.7	2.84	20	30	1300	0.25	75	1
MMBZ5224BLT1G	18D	2.66	2.8	2.94	20	30	1400	0.25	75	1
MMBZ5225BLT1G	18E	2.85	3	3.15	20	29	1600	0.25	50	1
MMBZ5226BLT1G	8A	3.13	3.3	3.47	20	28	1600	0.25	25	1
MMBZ5227BLT1G	8B	3.42	3.6	3.78	20	24	1700	0.25	15	1
MMBZ5228BLT1G	8C	3.70	3.9	4.10	20	23	1900	0.25	10	1
MMBZ5229BLT1G	8D	4.08	4.3	4.52	20	22	2000	0.25	5	1
MMBZ5230BLT1G	8E	4.46	4.7	4.94	20	19	1900	0.25	5	2
MMBZ5231BLT1G/T3G	8F	4.84	5.1	5.36	20	17	1600	0.25	5	2
MMBZ5232BLT1G/T3G	8G	5.32	5.6	5.88	20	11	1600	0.25	5	3
MMBZ5233BLT1G	8H	5.70	6	6.30	20	7	1600	0.25	5	3.5
MMBZ5234BLT1G/T3G	8J	5.89	6.2	6.51	20	7	1000	0.25	5	4
MMBZ5235BLT1G	8K	6.46	6.8	7.14	20	5	750	0.25	3	5
MMBZ5236BLT1G	8L	7.12	7.5	7.88	20	6	500	0.25	3	6
MMBZ5237BLT1G	8M	7.79	8.2	8.61	20	8	500	0.25	3	6.5
MMBZ5238BLT1G	8N	8.26	8.7	9.14	20	8	600	0.25	3	6.5
MMBZ5239BLT1G	8P	8.64	9.1	9.56	20	10	600	0.25	3	7
MMBZ5240BLT1G	8Q	9.50	10	10.50	20	17	600	0.25	3	8
MMBZ5241BLT1G/T3G	8R	10.4	11	11.55	20	22	600	0.25	2	8.4
MMBZ5242BLT1G/T3G	8S	11.40	12	12.60	20	30	600	0.25	1	9.1
MMBZ5243BLT1G	8T	12.35	13	13.65	9.5	13	600	0.25	0.5	9.9
MMBZ5244BLT1G	8U	13.30	14	14.70	9	15	600	0.25	0.1	10
MMBZ5245BLT1G	8V	14.25	15	15.75	8.5	16	600	0.25	0.1	11
MMBZ5246BLT1G	8W	15.20	16	16.80	7.8	17	600	0.25	0.1	12
MMBZ5247BLT1G/T3G	8X	16.15	17	17.85	7.4	19	600	0.25	0.1	13
MMBZ5248BLT1G/T3G	8Y	17.10	18	18.90	7	21	600	0.25	0.1	14
MMBZ5249BLT1G	8Z	18.05	19	19.95	6.6	23	600	0.25	0.1	14
MMBZ5250BLT1G/T3G	81A	19.00	20	21.00	6.2	25	600	0.25	0.1	15
MMBZ5251BLT1G	81B	20.90	22	23.10	5.6	29	600	0.25	0.1	17
MMBZ5252BLT1G	81C	22.80	24	25.20	5.2	33	600	0.25	0.1	18
MMBZ5253BLT1G	81D	23.75	25	26.25	5	35	600	0.25	0.1	19
MMBZ5254BLT1G	81E	25.65	27	28.35	4.6	41	600	0.25	0.1	21
MMBZ5255BLT1G	81F	26.60	28	29.40	4.5	44	600	0.25	0.1	21
MMBZ5256BLT1G	81G	28.50	30	31.50	4.2	49	600	0.25	0.1	23
MMBZ5257BLT1G/T3G	81H	31.35	33	34.65	3.8	58	700	0.25	0.1	25
MMBZ5258BLT1G	81J	34.20	36	37.80	3.4	70	700	0.25	0.1	27
MMBZ5259BLT1G	81K	37.05	39	40.95	3.2	80	800	0.25	0.1	30
MMBZ5260BLT1G	81L	40.85	43	45.15	3	93	900	0.25	0.1	33
MMBZ5261BLT1G/T3G	81M	44.65	47	49.35	2.7	105	1000	0.25	0.1	36
MMBZ5262BLT1G	81N	48.45	51	53.55	2.5	125	1100	0.25	0.1	39
MMBZ5263BLT1G	81P	53.20	56	58.80	2.2	150	1300	0.25	0.1	43
MMBZ5264BLT1G	81Q	57.00	60	63.00	2.1	170	1400	0.25	0.1	46
MMBZ5265BLT1G	81R	58.90	62	65.10	2	185	1400	0.25	0.1	47
MMBZ5266BLT1G	81S	64.60	68	71.40	1.8	230	1600	0.25	0.1	52
MMBZ5267BLT1G	81T	71.25	75	78.75	1.7	270	1700	0.25	0.1	56
MMBZ5268BLT1G	81U	77.90	82	86.10	1.5	330	2000	0.25	0.1	62
MMBZ5270BLT1G	81W	86.45	91	95.55	1.4	400	2300	0.25	0.1	69

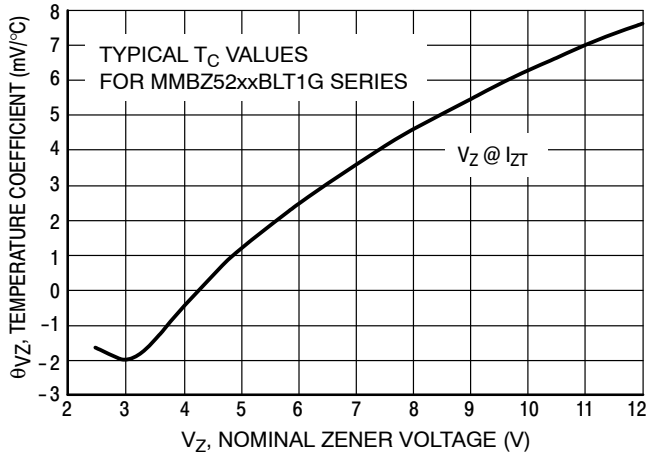
3. Zener voltage is measured with a pulse test current I<sub>Z</sub> at an ambient temperature of 25°C

NOTE: MMBZ5233BLT1G, MMBZ5246BLT1G, MMBZ5251BLT1G, and MMBZ5252BLT1G Not Available in 10,000/Tape & Reel.

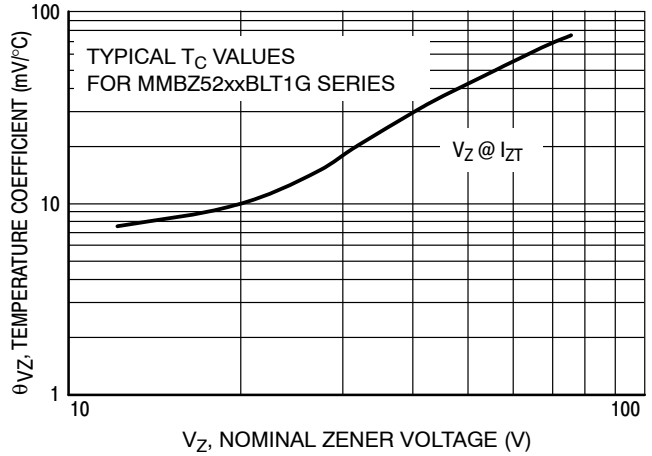
\*Include SZ-prefix devices where applicable.

# MMBZ52xxBLT1G Series, SZMMBZ52xxBLT1G Series

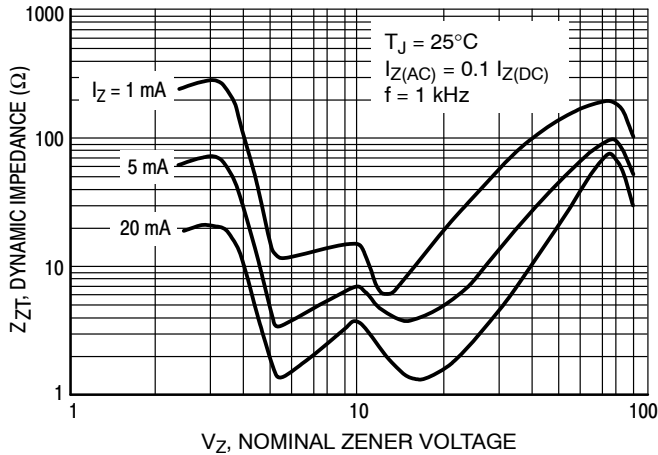
## TYPICAL CHARACTERISTICS



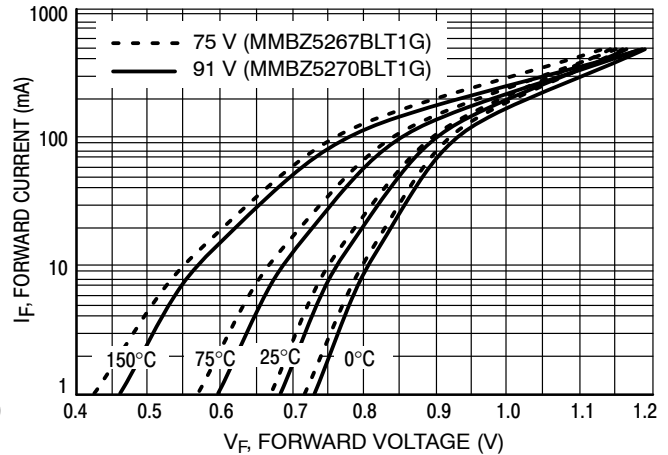
**Figure 1. Temperature Coefficients**  
(Temperature Range -55°C to +150°C)



**Figure 2. Temperature Coefficients**  
(Temperature Range -55°C to +150°C)



**Figure 3. Effect of Zener Voltage on Zener Impedance**



**Figure 4. Typical Forward Voltage**

TYPICAL CHARACTERISTICS

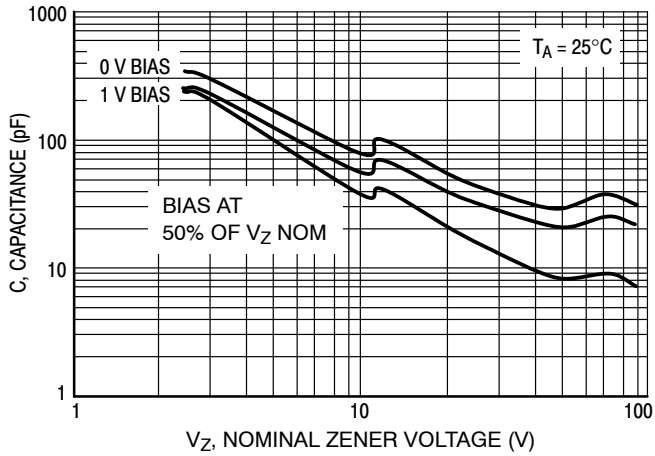


Figure 5. Typical Capacitance

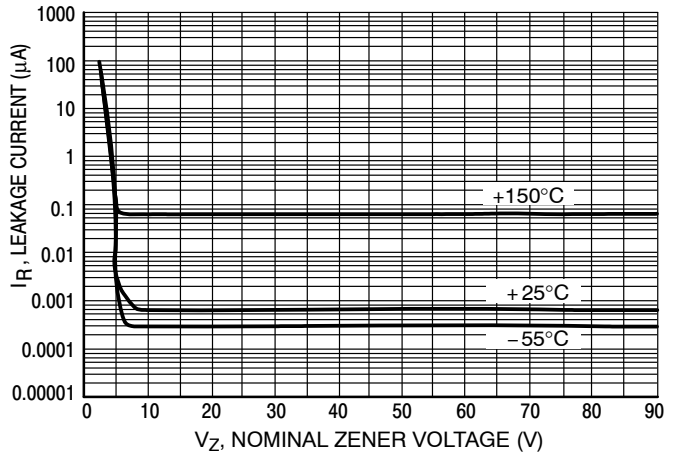


Figure 6. Typical Leakage Current

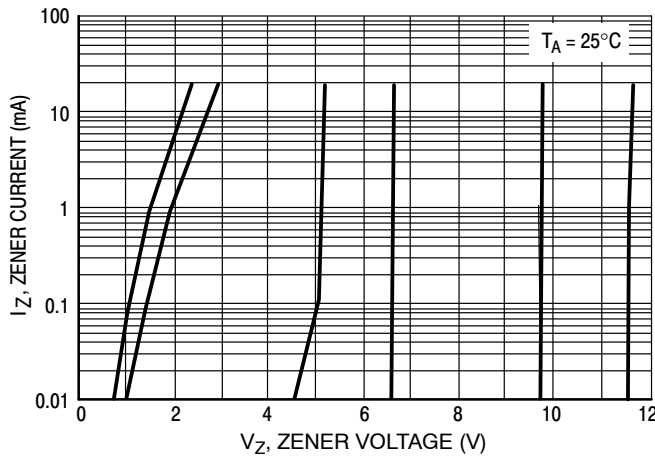


Figure 7. Zener Voltage versus Zener Current ( $V_Z$  Up to 12 V)

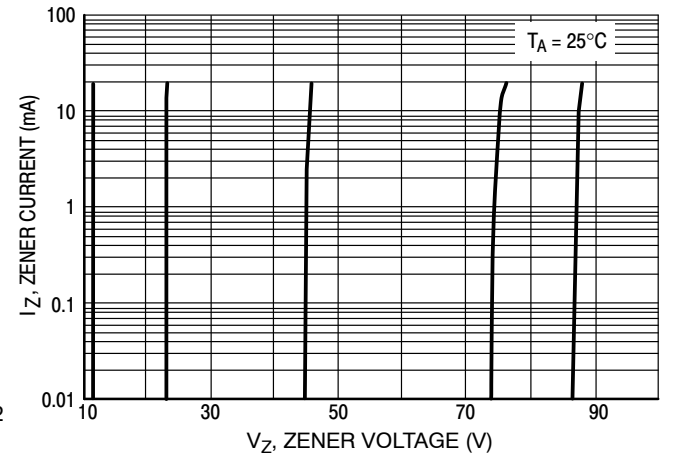
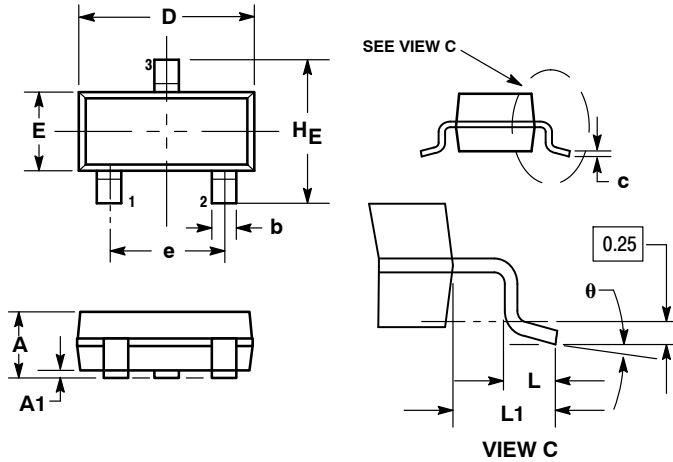


Figure 8. Zener Voltage versus Zener Current (12 V to 91 V)

# MMBZ52xxBLT1G Series, SZMMBZ52xxBLT1G Series

## PACKAGE DIMENSIONS

SOT-23 (TO-236)  
CASE 318-08  
ISSUE AP



NOTES:

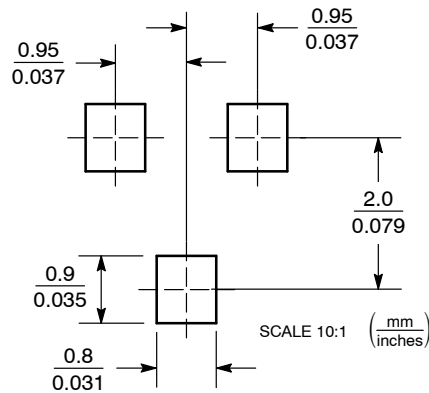
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104
θ	0°	---	10°	0°	---	10°

STYLE 8:

1. ANODE
2. NO CONNECTION
3. CATHODE

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.